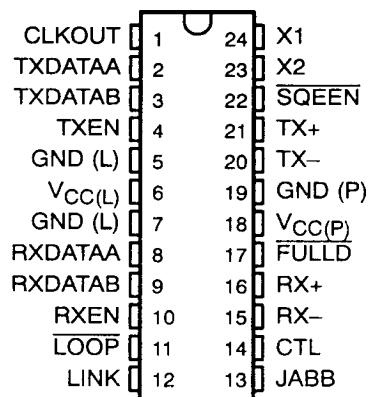


SN75LBC086  
DIFFERENTIAL I/O DRIVER/RECEIVER PAIR  
WITH SQUELCH, JABBER CONTROL, AND COLLISION DETECTION  
D3525, JUNE 1991-REVISED SEPTEMBER 1991

- Compliant With IEEE STD 802.3I,  
Type 10BASE-T
- Differential (Twisted-Pair) I/O  
Driver/Receiver
- High-Speed Receiver . . .  $t_{pd} = 50$  ns Max
- Receiver Squelch Circuit Integrity Improved  
With Noise Filter
- Jabber Control Prevents Network Lockup
- Collision Detection for Multiple-User  
Networks
- Data Link Integrity Monitored With Link  
Test Pulse
- Externally Addressable Test Register  
Controls Signal Quality Error Testing
- CMOS and Raised ECL Compatible
- 24-Pin, 300-mil Dual-In-Line Package

DW PACKAGE  
(TOP VIEW)



### description

The SN75LBC086 is a single-channel differential driver/receiver interface device for the medium attachment unit (MAU) used in 10-MHz twisted-pair Ethernet applications. The device uses a 5-V supply and is designed to interface with two pairs of telephone-grade twisted-pair cables coupled through isolation transformers. The functional components of the device include a differential receiver and driver, receiver squelch with noise filter, jabber controls, collision detection, data link monitor, and signal quality error (SQE) testing. The LinBiCMOS™ process technology is used in the device design to ensure analog precision, low power, and high-speed operation.

The device contains an elaborate receiver-squelch circuit<sup>†</sup> that provides an improved level of noise rejection by qualifying the incoming signal stream with three different criteria. First, the signal is compared to a set threshold voltage level. Then, the pulse duration is compared to a set time window. Last, the signal must follow a set pattern of positive and negative pulses before the circuit finally opens the receiver channel to the incoming data packet.

The jabber control is designed to prevent a defective controller from locking up the network by limiting the data packet transmission time to 20 to 30 ms. When a packet length exceeds 20 to 30 ms, the driver is turned off for about 600 ms. The driver-enable input must be made inactive by the controller during this period before the jabber control will release the driver. The JABB output is active (high) when a jabber condition exists.

Collision detection is used to arbitrate access to the multi-user network. This detection is done logically by monitoring the receive line for a valid signal during a driver transmission. When a collision is detected, this device informs the controller with an active-high CTL output. After a valid packet transmission, the device also performs a signal quality error test causing the CTL output to go active (high). This test is disabled when the SQEEN input goes inactive (high).

The device tests data-link integrity during the idle state by periodically driving the driver line with a unipolar pulse called a link-test pulse. The receiver looks for this link-test pulse on the receive line. A failed line link is indicated by a high-impedance state at the LINK output. This output drives an LED for monitoring if needed.

<sup>†</sup> Embodies technology covered by one or more Digital Equipment Corporation Patents.

LinBiCMOS is a trademark of Texas Instruments Incorporated.

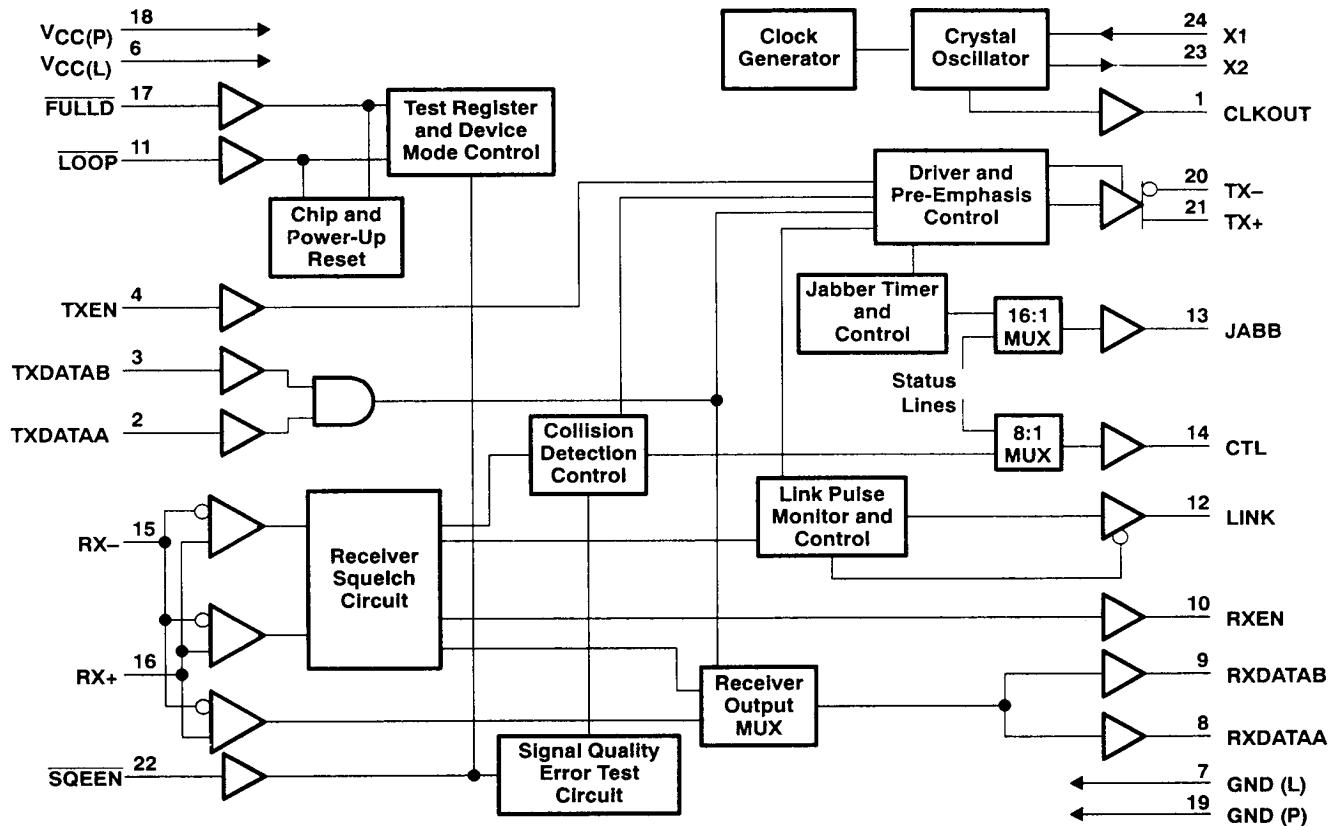
# SN75LBC086

## DIFFERENTIAL I/O DRIVER/RECEIVER PAIR WITH SQUELCH, JABBER CONTROL, AND COLLISION DETECTION

### description (continued)

An internal test register is externally controlled with inputs FULLD and LOOP to select the device testing mode. When in the test mode, serial test-mode control patterns are clocked into the test register through input SQEEN. These control patterns select various modes to test the internal circuits.

### functional block diagram



**TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN75LBC086  
DIFFERENTIAL I/O DRIVER/RECEIVER PAIR  
WITH SQUELCH, JABBER CONTROL, AND COLLISION DETECTION

**Terminal Functions**

PIN				DESCRIPTION
NAME	LEVEL	I/O	NO.	
CLKOUT	CMOS	O	1	Clock Output. This 10-MHz buffered clock is provided for driving other interface devices.
CTL	CMOS	O	14	Control. In normal mode, CTL high indicates a collision. In test mode, status lines are muxed out.
FULLD	TTL	I	17	Full-Duplex Mode. When active (low), the device is placed in the full-duplex operating mode for simple point-to-point communication applications. In the full-duplex mode, the receiver and driver are both active with collision detection disabled. After <u>LOOP</u> and <u>FULLD</u> go active (low), in that order, a device reset is initiated and while both are active (low), test select data is clocked into the test register using a 100-ns clock at the X1 input. This terminal is held inactive (high) due to an internal pullup resistor.
GND (L)	GROUND	5		Logic Grounds. These terminals provide a ground return for the CMOS core logic.
GND (P)	GROUND	7		
GND (P)	GROUND	19		Power Ground. This provides a ground return for the input and output buffers, driver (transmitter), and receiver circuits.
JABB	CMOS	O	13	Jabber Control. When a jabber condition exists during normal mode operation, this signal goes active (high) to report jabber-control status to the controller. In the test mode, this provides a multiplexed signal for internal timer and counter functions.
LINK	CMOS	O	12	Link Status. This 3-state output indicates the status of the receiver and interface link. When driving an LED (with anode to resistor to VCC), a high-impedance level indicates a failed link and the LED is off. A momentary high level indicates the device is receiving valid data and the LED is blinking on and off. A continuous low level indicates the device is receiving valid link pulses but no data, and the LED is on.
LOOP	TTL	I	11	Loop-Back Mode. When the device is in the normal operating mode (not test mode) and <u>LOOP</u> is active (low), the driver (transmit) data is directed to the receive data path to put the device in the loop-back mode and the driver is turned off. After <u>LOOP</u> and <u>FULLD</u> go active (low), in that order, a device reset is initiated and while both are active (low), test select data is clocked into the test register using a 100-ns clock at the X1 input. This terminal is held inactive (high) due to an internal pullup resistor.
RX+		I	16	Differential Receiver Inputs
RX-		I	15	
RXEN	CMOS	O	10	Receiver Squelch Status. This provides squelch status information to the controller. When active (high), this signal indicates that the data path is valid or open from the receive channel through the device. An inactive (low) indicates that the receive channel is squelched or closed. This signal is capable of driving an LED monitor.
RXDATAA	CMOS	O	8	Received-Data Serial Outputs. This provides a choice of logic levels and serial data either from the differential receiver input (RX+ and RX-) or data from the controller (TXDATAA or TXDATAB) when in the loop-back mode. When the receiver is idle, these output levels are normally high. This terminal is held inactive (high) due to an internal pullup resistor.
RXDATAB	ECL	O	9	
SQEEN	TTL	I	22	Signal-Quality Error Test Enable. In normal operating mode, this enables the SQE test function performed at the end of a data packet transmission. In the test mode, <u>SQEEN</u> is used (with X1 clock) as a serial data input port to load test patterns or selections into the test register. This terminal is held inactive (high) due to an internal pullup resistor.
TX+		O	21	Differential Driver Outputs
TX-		O	20	
TXEN	TTL	I	4	Transmitter (Driver) Enable. When TXEN is active (high), serial data at the TXDATA inputs starts and stops the driver. When TXEN is inactive (low), the driver begins transmitting an idle signal independent of the TXDATA inputs.
TXDATAA	CMOS	I	2	Transmit-Data Inputs. A choice of logic-level inputs provide Manchester-encoded serial data to the driver.
TXDATAB	ECL	I	3	Internal pullup resistors are included.
VCC(L)	SUPPLY	6		VCC Logic Power Supply. This provides power to the CMOS core logic.
VCC(P)	SUPPLY	18		VCC Power Supply. This provides power to the input and output buffers, drivers, and receivers.
X1	CMOS	I	24	Crystal Input/Output. X1 provides an input from an external 10-MHz crystal or another external clock source if the crystal is disconnected. X2 provides an oscillator output.
X2	O	23		



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

**SN75LBC086****DIFFERENTIAL I/O DRIVER/RECEIVER PAIR  
WITH SQUELCH, JABBER CONTROL, AND COLLISION DETECTION****absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

Supply voltage range, $V_{CC}$ (see Note 1) .....	-0.5 V to 7 V
Input voltage range at any input, $V_I$ .....	-0.5 V to 5.5 V
Output voltage range at any output, $V_O$ .....	-0.5 V to 7 V
Continuous total dissipation .....	See Dissipation Rating Table
Operating free-air temperature range, $T_A$ .....	0°C to 70°C
Storage temperature range .....	-65°C to 150°C
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds .....	260°C

NOTE 1: All voltages are with respect to device ground pins GND(L) and GND(P) shorted together.

**DISSIPATION RATING TABLE**

PACKAGE	$T_A \leq 25^\circ C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ C$	$T_A = 70^\circ C$ POWER RATING
DW	1350 mW	10.8 mW/°C	864 mW

**recommended operating conditions**

		MIN	NOM	MAX	UNIT
Supply voltage, $V_{CC}$		4.75	5	5.25	V
High-level output voltage, $V_{IH}$	TXDATAA, X1	3.15			V
	TXDATAB (see Figure 1)	$0.984V_{CC}-0.922$	$0.984V_{CC}-0.763$		
		$0.984V_{CC}-0.877$	$0.984V_{CC}-0.727$		
		$0.984V_{CC}-0.825$	$0.984V_{CC}-0.645$		
Low-level output voltage, $V_{IL}$	TXEN, LOOP, FULLD, SQEEN		2		V
	TXDATAA, X1			0.8	
	TXDATAB (see Figure 1)	$0.75V_{CC}-0.590$	$0.750V_{CC}-0.375$		
		$0.75V_{CC}-0.550$	$0.750V_{CC}-0.350$		
		$0.75V_{CC}-0.531$	$0.750V_{CC}-0.324$		
	TXEN, LOOP, FULLD, SQEEN			0.8	
Differential input voltage, $V_{ID}$		0.586		2.8	V
Common-mode input voltage, $V_{IC}$		1.8		3.2	V
Operating free-air temperature, $T_A$		0		70	°C



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN75LBC086  
DIFFERENTIAL I/O DRIVER/RECEIVER PAIR  
WITH SQUELCH, JABBER CONTROL, AND COLLISION DETECTION

electrical characteristics over recommended operating free-air temperature and supply voltage range (unless otherwise noted)

drivers

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT	
VOH	High-level output voltage	CLKOUT, RXDATAA, RXEN, JABB, CTL		$I_{OH} = -12 \text{ mA}$		3.7	V	
		RXDATAB	See Figure 1	$T_A = 0^\circ\text{C}$	0.984 $\text{V}_{CC}$ –0.922	0.984 $\text{V}_{CC}$ –0.763		
				$T_A = 25^\circ\text{C}$	0.984 $\text{V}_{CC}$ –0.877	0.984 $\text{V}_{CC}$ –0.727		
				$T_A = 70^\circ\text{C}$	0.984 $\text{V}_{CC}$ –0.825	0.984 $\text{V}_{CC}$ –0.645		
VOL	Low-level output voltage	CLKOUT, RXDATAA, RXEN, JABB, CTL		$I_{OL} = 16 \text{ mA}$		0.5	V	
		RXDATAB	See Figure 1	$T_A = 0^\circ\text{C}$	0.750 $\text{V}_{CC}$ –0.590	0.750 $\text{V}_{CC}$ –0.375		
				$T_A = 25^\circ\text{C}$	0.750 $\text{V}_{CC}$ –0.550	0.750 $\text{V}_{CC}$ –0.350		
				$T_A = 70^\circ\text{C}$	0.750 $\text{V}_{CC}$ –0.531	0.750 $\text{V}_{CC}$ –0.324		
LINK		$I_{OL} = 12 \text{ mA}$				0.5	V	
VOD	Differential-output voltage (Peak)	See Figure 2		2.2		2.8	V	
VOD	Differential-output voltage (Step)	See Figure 2		1.53		1.982	V	
Common-mode driver impedance	TX+, TX–			2	5	8	$\Omega$	

receivers

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT				
I <sub>IH</sub>	High-level input current	TXDATAA, TXEN, LOOP, FULLD, SQEEN		$V_I = 5.25 \text{ V}$		20	$\mu\text{A}$				
		X1				100					
		TXDATAB		$V_{IH} = \text{Max}$		400					
		TXDATAA, TXEN, LOOP, FULLD, SQEEN		$V_I = 0$		–20					
I <sub>IL</sub>	Low-level input current					–100					
						–400					
	X1										
	TXDATAB		$V_{IL} = \text{Min}$								

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

drivers and receivers

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
I <sub>CC</sub>	Supply current	V <sub>CC(L)</sub> , V <sub>CC(P)</sub>	V <sub>CC(L)</sub> = 5.25 V, V <sub>CC(P)</sub> = 5.25 V			180	mA



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

**SN75LBC086****DIFFERENTIAL I/O DRIVER/RECEIVER PAIR  
WITH SQUELCH, JABBER CONTROL, AND COLLISION DETECTION****switching characteristics**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{pd1}$	Propagation delay time	RX+, RX-	RXEN	See Figure 4		5 bit times	
$t_{pd2}$	Propagation delay time at startup	RX+, RX-	RXDATAA or RXDATAB high	See Figure 4		75	ns
$t_{sk(o)}$	Output skew time	RXEN high	RXDATAA or RXDATAB low	See Figure 4		$\pm 10$	ns
$t_{pd3}$	Propagation delay time after startup	RX+, RX-	RXDATAA or RXDATAB high	See Figure 4		50	ns
$t_{sk(p)}$	Pulse skew time, $( t_{PLH4} - t_{PHL4} )$	RX+, RX-	RXDATAA or RXDATAAB	See Figure 4		2	ns
$t_{pd4}$	Propagation delay time	RX+, RX-	RXEN low	See Figure 5	155	250	ns
$t_{pd5}$	Propagation delay time	TXDATA or TXDATAB	TX+, TX-	See Figure 6		75	ns
$t_{sk(p)}$	Pulse skew time, $( t_{PLH5} - t_{PHL5} )$	TXDATAA or TXDATAB	TX+, TX-	See Figure 6		2	ns
$t_{pd6}$	Propagation delay time in loop mode	TXDATAA or TXDATAB	RXDATAA, RXDATAB	See Figure 7		50	ns
$t_{pd7}$	Propagation delay time in loop mode	TXEN high	RXEN high	See Figure 7		50	ns
$t_{pd8}$	Propagation delay time in loop mode	LOOP low	RXEN low	See Figure 7		30	ns
$t_{pd10}$	Propagation delay time	TXEN low	RXEN low	See Figure 8		350	ns
$t_{pd11}$	Propagation delay time	TXEN low	TX+, TX- high	See Figure 8		50	ns
$t_p1$	Precompensation pulse duration		TX+, TX-	See Figure 6	45	55	ns
$t_p2$	Receiver link-beat minimum pulse duration			See Figure 9	80	120	ns
$t_{en1}$	Enable time	TXDATAA or TXDATAB	TX+, TX-	See Figure 6		75	ns
$t_{en2}$	Enable time	TXEN	TX+, TX-	See Figure 6		75	ns
$t_{dis1}$	Disable time, caused by TXDATAA or TXDATAB high or TXEN low	TX+, TX- high	TX+, TX- at 585-mV level	See Figure 8	250		ns
$t_{pd12}$	Propagation delay time to looped RXEN	TXEN high	RXEN high	See Figure 6		100	ns
$t_{pd13}$	Propagation delay time for looped back data	TXDATAA or TXDATAB	RXDATAA or RXDATAB	See Figure 6		75	ns

**timing requirements**

	TEST CONDITIONS	MIN	NOM	MAX	UNIT
Setup time, test mode, SQEEN before X1↑, $t_{su1}$	See Figure 10	30			ns
Setup time, test mode, LOOP low before FULLD↓, $t_{su2}$	See Figure 10	25			ns
Hold time, test mode, SQEEN after X1↑, $t_{h1}$	See Figure 10	25			ns



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

**PARAMETER MEASUREMENT INFORMATION**

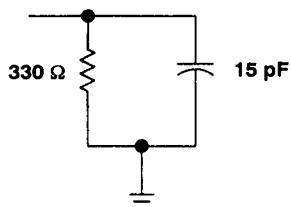


Figure 1. ECL Load Circuit

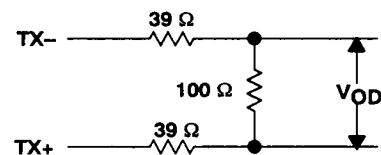


Figure 2. Differential Load Circuit

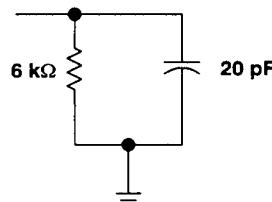


Figure 3. CMOS Load Circuit

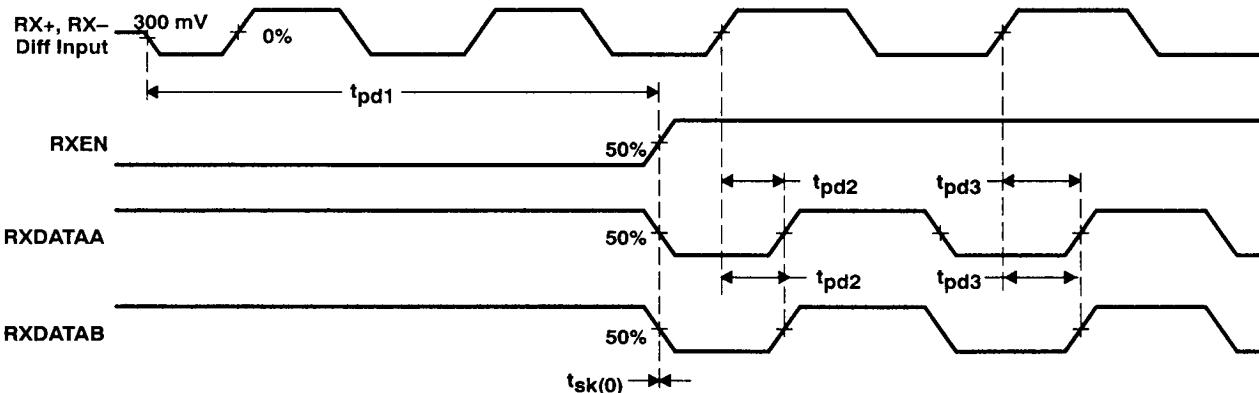


Figure 4. Receiver Startup Waveforms

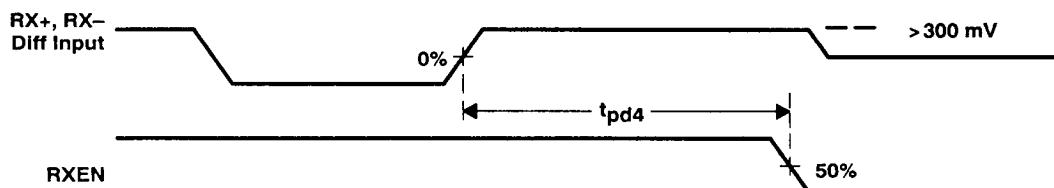


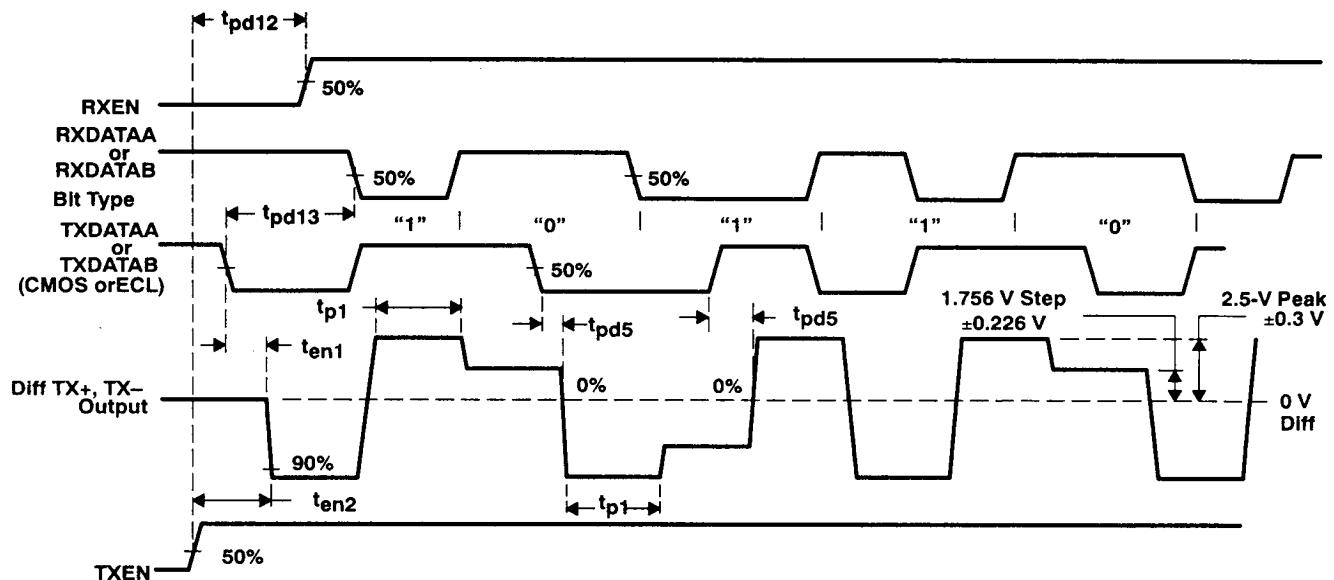
Figure 5. Receiver Shutdown Waveforms

**TEXAS  
INSTRUMENTS**

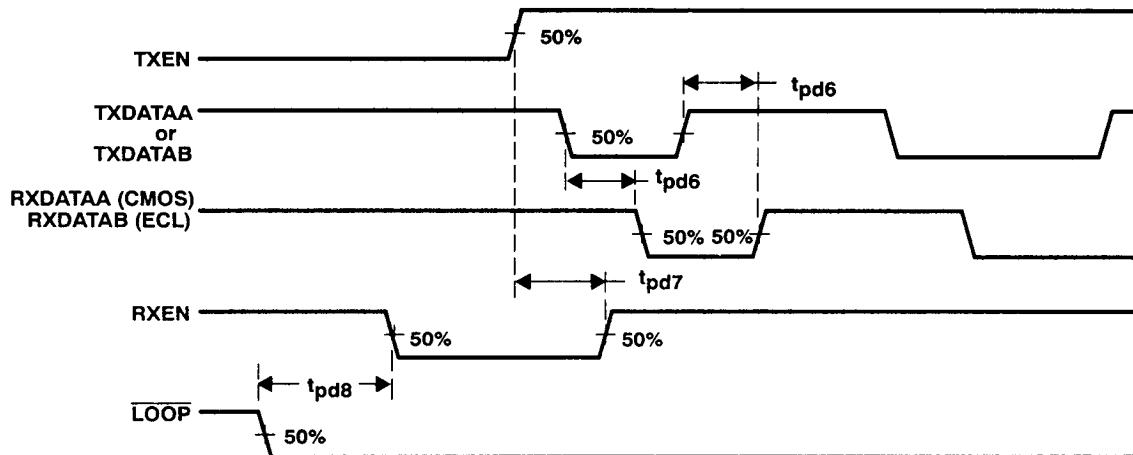
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

# **SN75LBC086** **DIFFERENTIAL I/O DRIVER/RECEIVER PAIR** **WITH SQUELCH, JABBER CONTROL, AND COLLISION DETECTION**

## PARAMETER MEASUREMENT INFORMATION



**Figure 6. Driver Startup Waveforms**



**Figure 7. Propagation Delay Waveforms in Loop Mode**

**PARAMETER MEASUREMENT INFORMATION**

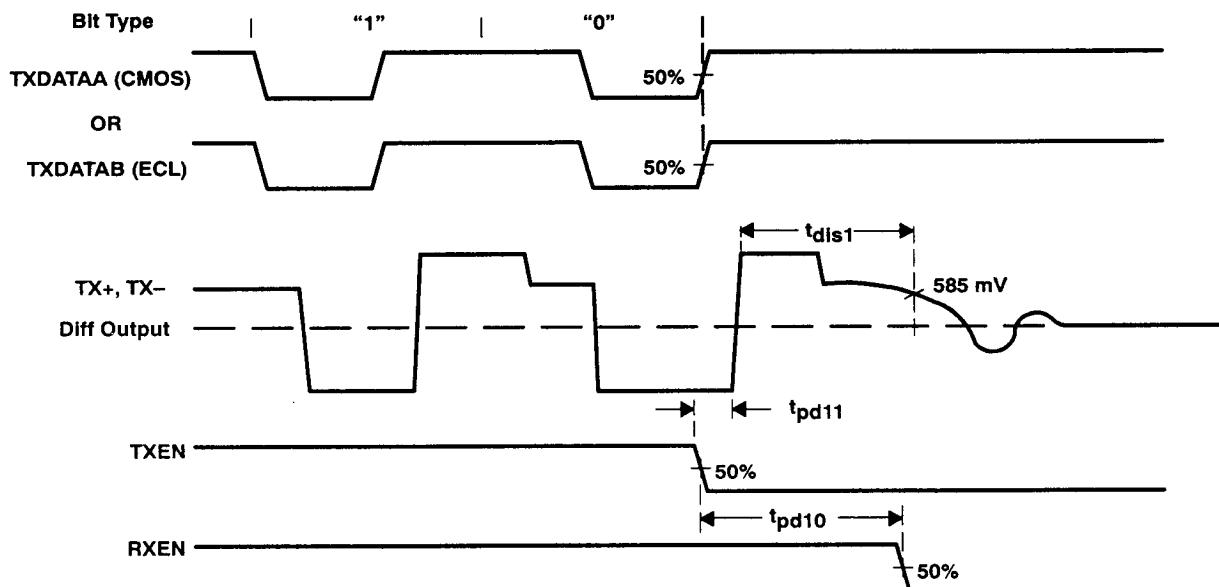


Figure 8. Driver Shutdown Waveforms

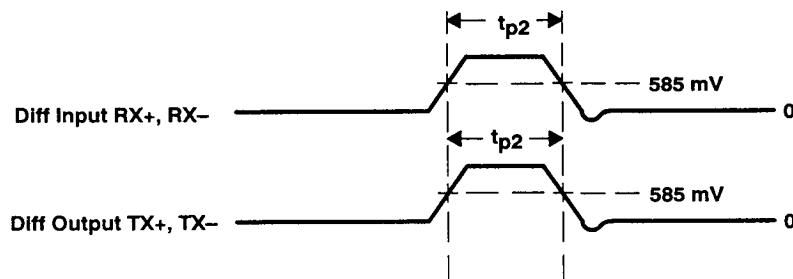


Figure 9. Link Beat Pulse Duration Waveform

 **TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

SN75LBC086

DIFFERENTIAL I/O DRIVER/RECEIVER PAIR  
WITH SQUELCH, JABBER CONTROL, AND COLLISION DETECTION

---

PARAMETER MEASUREMENT INFORMATION

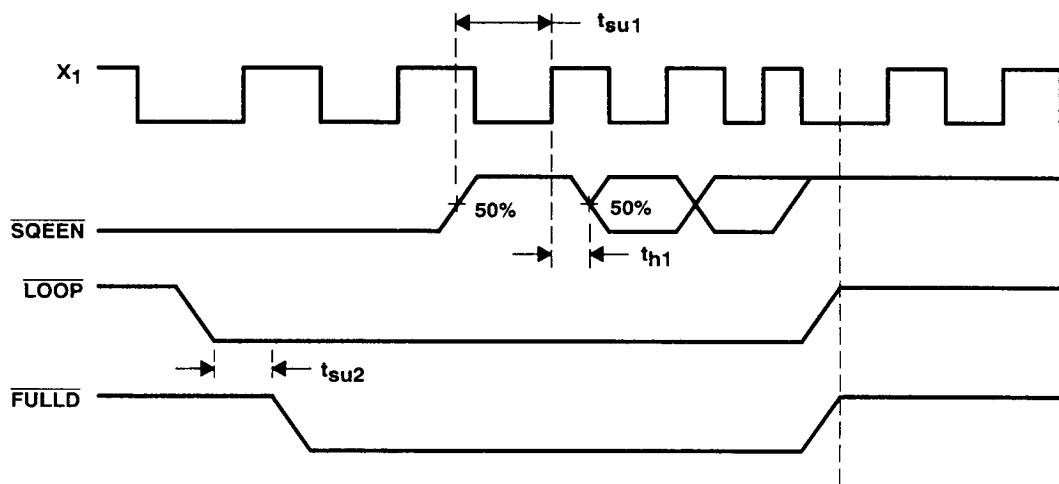


Figure 10. Setup and Hold Time Waveforms

---

TEXAS  
INSTRUMENTS

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265